# **BLF8G10LS-300P**

# **Power LDMOS transistor**

**AMPLEON** 

Rev. 3 — 1 September 2015

Product data sheet

# 1. Product profile

## 1.1 General description

300 W LDMOS power transistor for base station applications at frequencies from 700 MHz to 1000 MHz.

Table 1. Typical performance

Typical RF performance at  $T_{case} = 25$  °C in a common source class-AB production test circuit.

Test signal	f	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	η <sub>D</sub>	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	758 to 803	28	65	20.5	32	-35 <mark>[1]</mark>

<sup>[1]</sup> Test signal: 3GPP test model 1; 1 to 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz.

#### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

### 1.3 Applications

RF power amplifier for multi standards and multi carrier applications in the 700 MHz to 1000 MHz frequency range

# 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	e Graphic symbol
1	drain1		,
2	drain2		
3	gate1	5	3
4	gate2	3 4	5
5	source	U	4
			sym117

<sup>[1]</sup> Connected to flange.

# 3. Ordering information

Table 3. Ordering information

Type number	Packag	Package			
	Name	Description	Version		
BLF8G10LS-300P	-	earless flanged balanced ceramic package; 4 leads	SOT539B		

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
V <sub>GS</sub>	gate-source voltage		-0.5	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		<u>[1]</u> _	225	°C

<sup>[1]</sup> Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator

## 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-case)</sub>	thermal resistance from junction to case	$T_{case} = 80  ^{\circ}C;  P_{L} = 65  W$	0.29	K/W

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### 6. Characteristics

Table 6. DC characteristics

 $T_i = 25$  °C; values per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 2.2 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 20 V; $I_{D}$ = 220 mA	1.5	1.9	2.3	V
$V_{GSq}$	gate-source quiescent voltage	V <sub>DS</sub> = 28 V; I <sub>D</sub> = 1000 mA	-	2.0	-	V
$I_{DSS}$	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	2.4	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 20 \text{ V}$	-	38.1	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	240	nA
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = 20 V; $I_{D}$ = 11 A	-	15.0	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 7.7 A$	-	0.086	-	Ω

#### Table 7. RF characteristics

Test signal: 2-carrier W-CDMA; PAR = 7.2 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1$  = 760.5 MHz;  $f_2$  = 765.5 MHz;  $f_3$  = 795.5 MHz;  $f_4$  = 800.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA;  $T_{case}$  = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 65 \text{ W}$	19.5	20.5	-	dB
RLin	input return loss	P <sub>L(AV)</sub> = 65 W	-	-12	-8	dB
$\eta_{D}$	drain efficiency	P <sub>L(AV)</sub> = 65 W	28	32	-	%
ACPR	adjacent channel power ratio	P <sub>L(AV)</sub> = 65 W	-	-35	-32	dBc

### 7. Test information

### 7.1 Ruggedness in class-AB operation

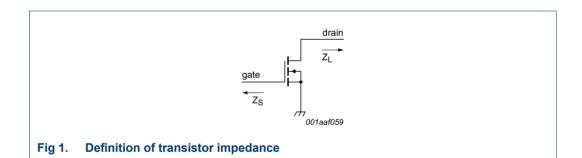
The BLF8G10LS-300P is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA;  $P_{L}$  = 65 W (2-carrier W-CDMA); f = 758 MHz.

# 7.2 Impedance information

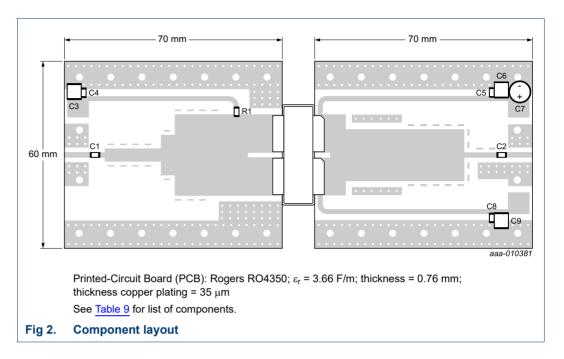
**Table 8. Typical impedance** Measured load-pull data per section;  $I_{Dq} = 1000 \text{ mA}$ ;  $V_{DS} = 28 \text{ V}$ 

f	Z <sub>S</sub> [1]	Z <sub>L</sub> [1]	P <sub>L(3dB)</sub>
(MHz)	(Ω)	(Ω)	(W)
720	2.3 – j2.8	1.6 – j2.7	204.4
746	2.5 - j3.2	1.7 – j2.6	220.0
757	2.3 - j3.6	1.6 – j2.5	225.2
769	2.6 - j3.6	1.7 – j2.4	227.9
791	2.6 - j3.9	1.5 – j2.8	214.8
805	2.6 - j3.9	1.8 – j2.3	207.2
820	2.7 – j4.2	1.6 – j2.1	228.5
869	2.8 – j4.1	1.2 – j2.1	217.2
881	2.9 - j4.4	1.2 – j2.1	219.9
894	3.3 - j4.7	1.1 – j2.1	215.4
925	3.6 – j5.2	1.2 – j2.1	223.5
942	4.1– j 5.7	1.1 – j2.2	220.5
960	4.7 – j5.9	1.1 – j2.2	218.8

[1]  $Z_S$  and  $Z_L$  defined in Figure 1.



#### 7.3 Test circuit



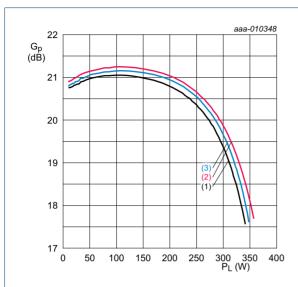
**Table 9. List of components** See Figure 2 for component layout.

Component **Description Value** Remarks C1, C2 multilayer ceramic chip capacitor 82 pF ATC 800B C3, C6, C9 multilayer ceramic chip capacitor  $10 \mu F$ , 50 VMurata C4, C5, C8 multilayer ceramic chip capacitor 82 pF ATC 100B C7 electrolytic capacitor 470 μF, 63 V R1 chip resistor 4.7 Ω SMD 1206

### 7.4 Graphical data

Following are typical RF measurements of the BLF8G10LS-300P in its class-AB test circuit.

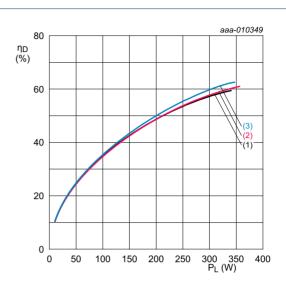
#### 7.4.1 CW pulsed



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA;  $t_p$  = 100  $\mu$ s:  $\delta$  = 10 %.

- (1) f = 758 MHz
- (2) f = 780.5 MHz
- (3) f = 803 MHz

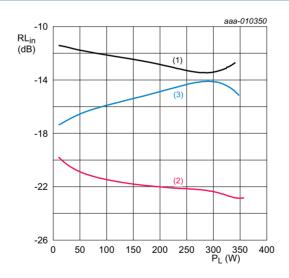
Fig 3. Power gain as a function of output power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA;  $t_p$  = 100  $\mu$ s:  $\delta$  = 10 %.

- (1) f = 758 MHz
- (2) f = 780.5 MHz
- (3) f = 803 MHz

Fig 4. Drain efficiency as a function of output power; typical values

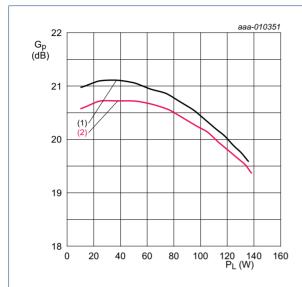


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA;  $t_p$  = 100  $\mu$ s:  $\delta$  = 10 %.

- (1) f = 758 MHz
- (2) f = 780.5 MHz
- (3) f = 803 MHz

Fig 5. Input return loss as a function of output power; typical values

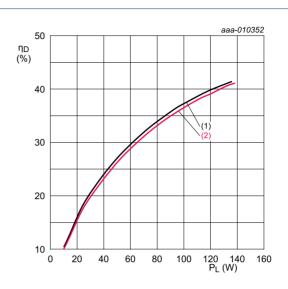
#### 7.4.2 1-Carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 758 MHz
- (2) f = 803 MHz

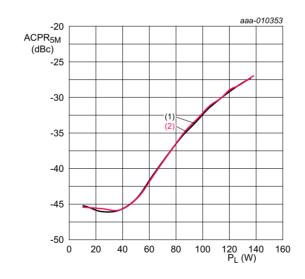
Fig 6. Power gain as a function of output power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 758 MHz
- (2) f = 803 MHz

Fig 7. Drain efficiency as a function of output power; typical values

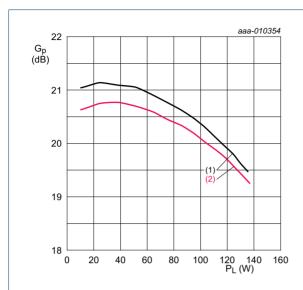


 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 758 MHz
- (2) f = 803 MHz

Fig 8. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

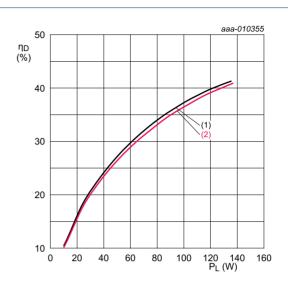
#### 7.4.3 2-Carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 758 MHz
- (2) f = 803 MHz

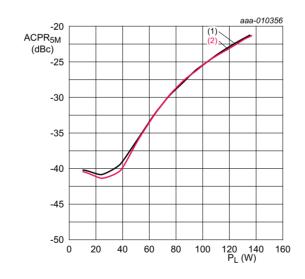
Fig 9. Power gain as a function of output power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 758 MHz
- (2) f = 803 MHz

Fig 10. Drain efficiency as a function of output power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 758 MHz
- (2) f = 803 MHz

Fig 11. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

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# 8. Package outline

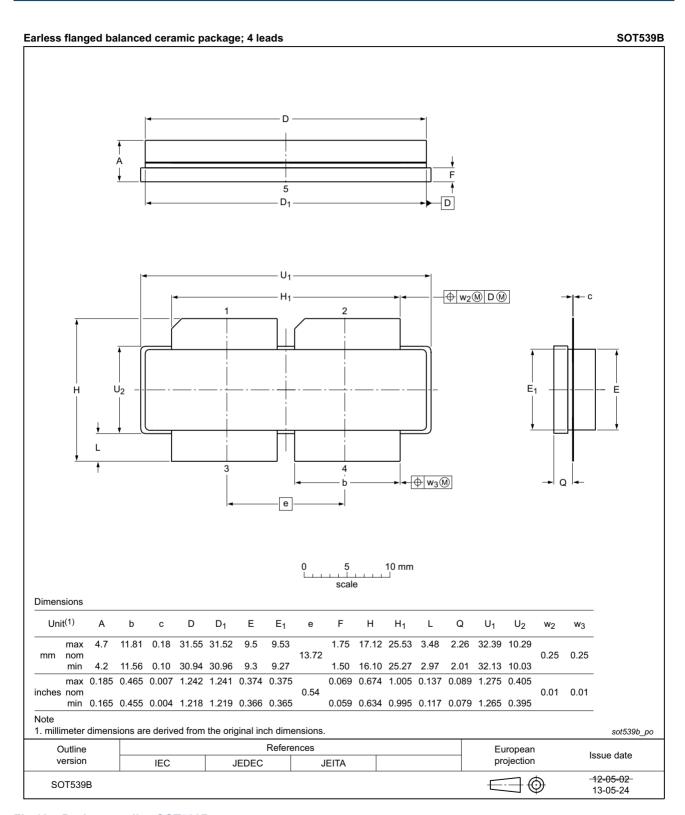


Fig 12. Package outline SOT539B

# 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

# 10. Abbreviations

Table 10. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
PAR	Peak-to-Average Ratio
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

# 11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF8G10LS-300P#3	20150901	Product data sheet	-	BLF8G10LS-300P v.2
Modifications:		<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> </ul>		
	<ul> <li>Legal texts</li> </ul>	have been adapted to the	new company name v	here appropriate.
BLF8G10LS-300P v.2	20131217	Product data sheet	-	BLF8G10LS-300P v.1
BLF8G10LS-300P v.1	20131118	Objective data sheet	-	-

# 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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# BLF8G10LS-300P

#### **Power LDMOS transistor**

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